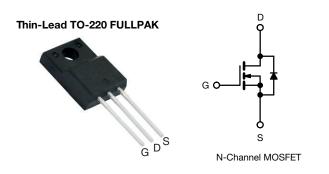


Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	650					
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$ 0.168					
Q _g max. (nC)	32					
Q _{gs} (nC)	7					
Q _{gd} (nC)	7					
Configuration	Single					

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free and halogen-free	SIHA186N60EF-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	v	
Gate-source voltage			V _{GS}	± 30	v	
Continuous drain current (T _J = 150 °C) e	$V_{GS} \text{ at 10 V} \frac{T_C = 25 \text{ °C}}{T_C = 100 \text{ °C}}$	T _C = 25 °C	1	8.4		
		ID	5.3	А		
Pulsed drain current ^a			I _{DM}	43	1	
Linear derating factor				0.26	W/°C	
Single pulse avalanche energy ^b			E _{AS}	24	mJ	
Maximum power dissipation	PD	33	W			
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +150	°C			
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	100	V/ns	
Reverse diode dv/dt d				50		
Soldering recommendations (peak temperature) ^c	For 10 s		-	260	°C	
Mounting torque	M3 screw		-	0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,$ I_{AS} = 1.3 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, di/dt$ = 700 A/µs, starting T_J = 25 $^\circ C$

e. Limited by maximum junction temperature

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1 For technical questions, contact: <u>hvm@vishay.com</u>





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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R _{thJA}	-	65	°C/W		
Maximum junction-to-case (drain)	R _{thJC}	-	3.8	C/W		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.69	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3.0	-	5.0	V
	I _{GSS}	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gate-source leakage		Ň	V _{GS} = ± 30 V		-	± 1	μA
	_	V _{DS} =	V _{DS} = 480 V, V _{GS} = 0 V		-	1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 9.5 A	-	0.168	0.193	Ω
Forward transconductance ^a	g _{fs}	V _{DS} =	= 20 V, I _D = 9.5 A	-	5.4	-	S
Dynamic		-				•	
Input capacitance	C _{iss}		$V_{GS} = 0 V$,	-	1081	-	-
Output capacitance	C _{oss}	,	$V_{\rm DS} = 100 \rm V,$	-	52	-	
Reverse transfer capacitance	C _{rss}	_	f = 1 MHz		5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{\rm DS}$ = 0 V to 480 V, $V_{\rm GS}$ = 0 V		-	40	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	247	-	
Total gate charge	Qg		V _{GS} = 10 V I _D = 9.5 A, V _{DS} = 480 V		21	32	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$			7	-	nC
Gate-drain charge	Q _{gd}	1 [-	7	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 480 V, I _D = 9.5 A,		-	14	28	- ns
Rise time	t _r			-	23	46	
Turn-off delay time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		25	50	
Fall time	t _f	1		-	16	32	
Gate input resistance	Rg	f = 1 MHz, open drain		0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s				-		
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	18	
Pulsed diode forward current	I _{SM}			-	-	43	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 9.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 9.5 \text{ A},$ $di/dt = 100 \text{ A}/\mu \text{s}, V_{R} = 400 \text{ V}$		-	111	222	ns
Reverse recovery charge	Q _{rr}			-	0.6	1.2	μC
Reverse recovery current	I _{RRM}			-	10	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

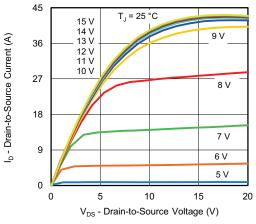


Fig. 1 - Typical Output Characteristics

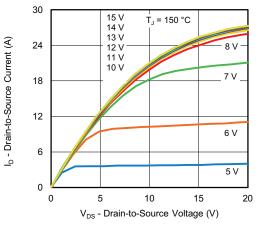


Fig. 2 - Typical Output Characteristics

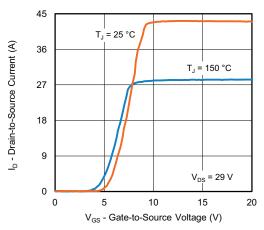


Fig. 3 - Typical Transfer Characteristics

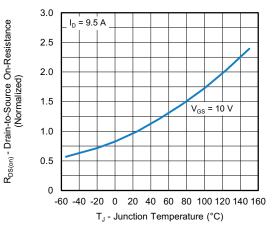


Fig. 4 - Normalized On-Resistance vs. Temperature

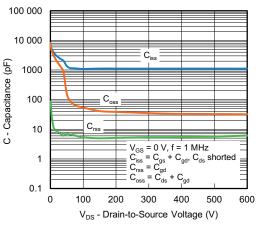


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

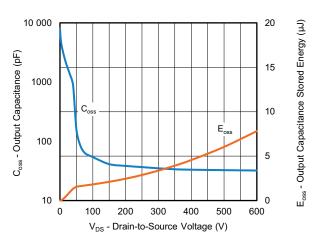


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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3 questions contact: hym@vis Document Number: 92331

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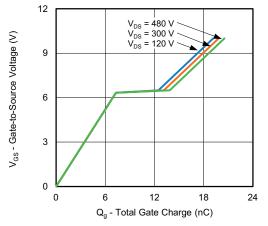


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

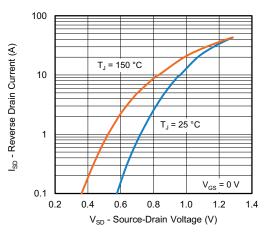


Fig. 8 - Typical Source-Drain Diode Forward Voltage

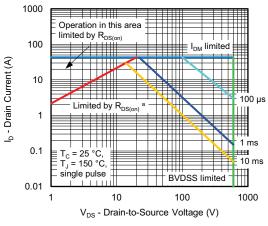


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

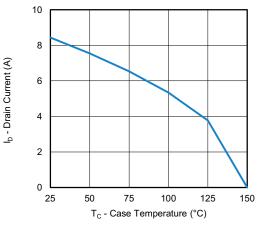


Fig. 10 - Maximum Drain Current vs. Case Temperature

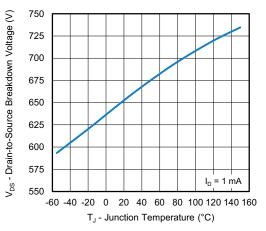


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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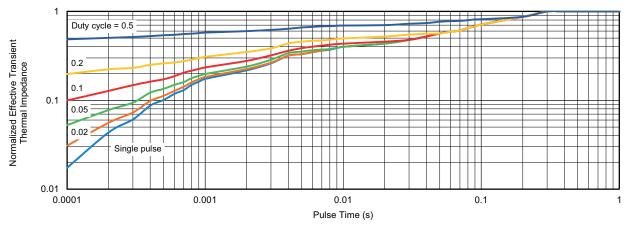


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

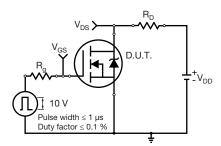


Fig. 13 - Switching Time Test Circuit

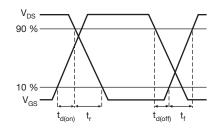


Fig. 14 - Switching Time Waveforms

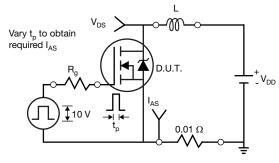


Fig. 15 - Unclamped Inductive Test Circuit

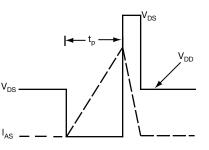


Fig. 16 - Unclamped Inductive Waveforms

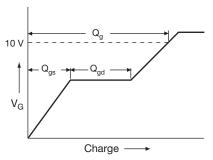


Fig. 17 - Basic Gate Charge Waveform

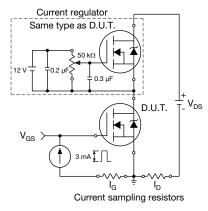


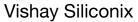
Fig. 18 - Gate Charge Test Circuit

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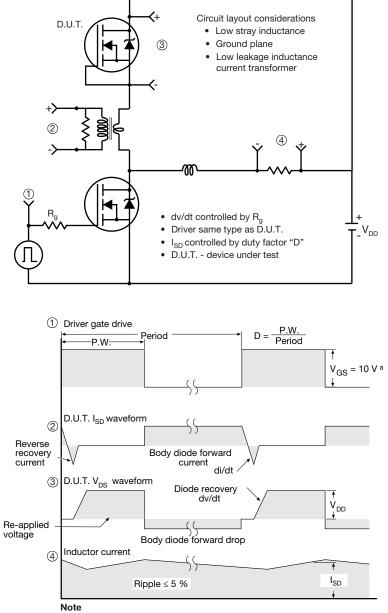
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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

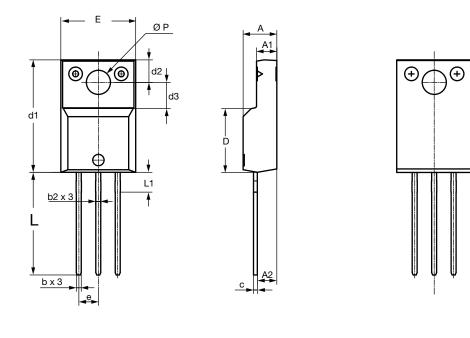
Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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